Electronic Pa	cent whi	cation rec		ai			
Application Number:	103	10779397					
Filing Date:	13-	13-Feb-2004					
Title of Invention:		SUBSTRATE PROCESSING APPARATUS AND SUBSTRATE PROCESSING METHOD					
First Named Inventor/Applicant Name:	Na	Naoki Shindo					
Filer:	Da	David Tai-Wei Yang/Vivian Gutierrez					
Attorney Docket Number:	199	199372003910					
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:					1		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		1501	1	1510	1510		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:	·			
Miscellaneous:				
Printed copy of patent - no color	8001	1	3	3
	Tot	Total in USD (\$)		